DTA144TU3 HZG

PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

AEC-Q101 Qualified

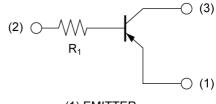
| Parameter | Value | |
|------------------|--------|--|
| V _{CEO} | -50V | |
| I _C | -100mA | |
| R ₁ | 47kΩ | |

Outline SOT-323 SC-70 (UMT3)

Features

- 1) Built-In Biasing Resistors, $R_1 = 47k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC144TU3 HZG

•Inner circuit



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Quantity (pcs) | Marking |
|---------------|-------------------|-----------------|----------------|-------------------|-----------------|-------------------|---------|
| DTA144TU3 HZG | SOT-323 (UMT3) | 2021 | T106 | 180 | 8 | 3000 | 96 |

● **Absolute maximum ratings** (T_a = 25°C)

| Parameter | Symbol | Values | Unit |
|------------------------------|-------------------|-------------|------|
| Collector-base voltage | V_{CBO} | -50 | V |
| Collector-emitter voltage | V _{CEO} | -50 | V |
| Emitter-base voltage | V _{EBO} | -5 | V |
| Collector current | I _C *1 | -100 | mA |
| Power dissipation | P _D *2 | 200 | mW |
| Junction temperature | Tj | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

● Electrical characteristics (T_a = 25°C)

| Parameter | Symbol | Conditions | Values | | | Lloit |
|--------------------------------------|---------------------------------------------------------|-------------------------------------------------------------|--------|------|------|-------|
| Parameter | Symbol Conditions - | | Min. | Тур. | Max. | Unit |
| Collector-base breakdown voltage | BV _{CBO} | I _C = -50μA | -50 | - | - | ٧ |
| Collector-emitter breakdown voltage | BV _{CEO} | I _C = -1mA | -50 | - | - | V |
| Emitter-base breakdown voltage | BV _{EBO} | I _E = -50μA | -5 | 1 | - | V |
| Collector cut-off current | I _{CBO} | V _{CB} = -50V | - | 1 | -500 | nA |
| Emitter cut-off current | mitter cut-off current I _{EBO} V _{ER} | | - | 1 | -500 | nA |
| Collector-emitter saturation voltage | V _{CE(sat)} | $I_C = -5mA, I_B = -0.5mA$ | - | - | -300 | mV |
| DC current gain | h _{FE} | $V_{CE} = -5V, I_{C} = -1mA$ | 100 | 250 | 600 | - |
| Input resistance | R ₁ | - | 32.9 | 47 | 61.1 | kΩ |
| Transition frequency | f _T *1 | V _{CE} = -10V, I _E = 5mA, f = 100MHz | - | 250 | - | MHz |

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Grounded emitter propagation characteristics

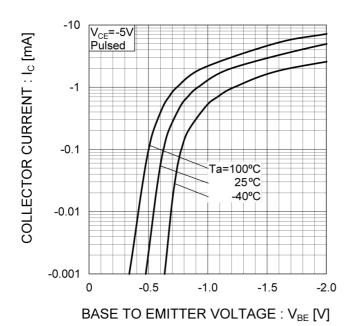
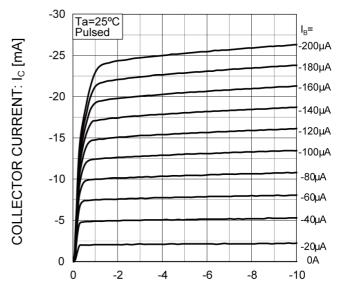


Fig.2 Grounded emitter output characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current gain vs. Collector Current

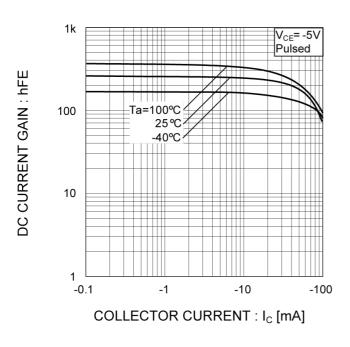
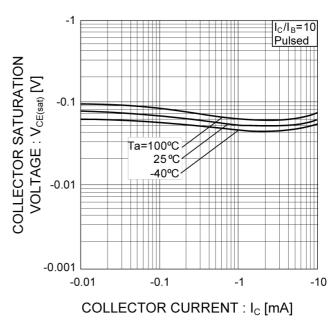
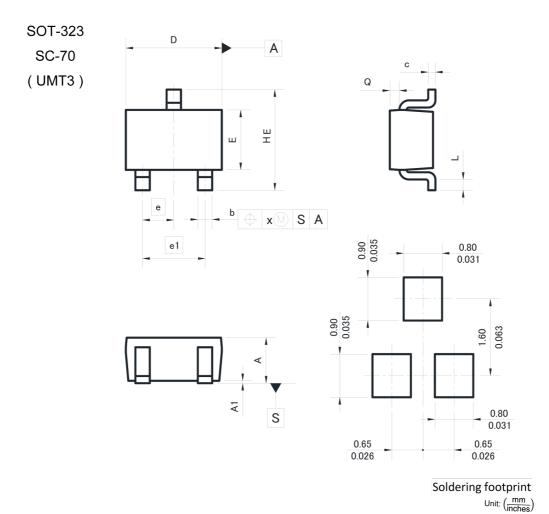


Fig.4 Collector-emitter saturation voltage vs. Collector Current



Dimensions



| DIM | Millim | eters | Inches | | |
|-------|---------|-----------|--------|-------|--|
| DIIVI | Min. | Max. | Min. | Max. | |
| Α | 0.80 | 1.10 | 0.031 | 0.043 | |
| A1 | A1 0.00 | | 0.000 | 0.004 | |
| b | 0.25 | 0.40 | 0.010 | 0.016 | |
| С | 0.10 | 0.20 | 0.004 | 0.008 | |
| D | 1.90 | 2.10 | 0.075 | 0.083 | |
| E | 1.15 | 1.15 1.35 | | 0.053 | |
| е | 0.6 | 35 | 0.026 | | |
| e1 | 1.3 | 30 | 0.051 | | |
| HE | 2.00 | 2.20 | 0.079 | 0.087 | |
| L | 0.10 | _ | 0.004 | - | |
| Q | 0.10 | 0.30 | 0.004 | 0.012 | |
| Х | - | 0.10 | - | 0.004 | |

Dimension in mm / inches



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(Note1) Medical Equipment Classification of the Specific Applications

| (110to 1) Wouldar Equipment Glassingation of the openior application | | | | | | |
|----------------------------------------------------------------------|----------|------------|----------|--|--|--|
| JAPAN | USA | EU | CHINA | | | |
| CLASSⅢ | CLASSIII | CLASS II b | CLASSIII | | | |
| CLASSIV | CLASSIII | CLASSⅢ | CLASSIII | | | |

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 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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